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Schottky Barrier Diode Silicon Epitaxial

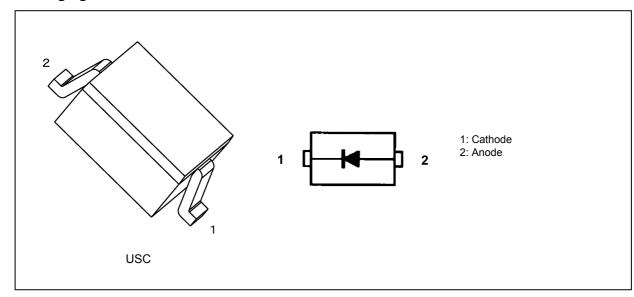
CUS15S40

1. Applications

High-Speed Switching

2. Features

- (1) Small package
- (2) Low forward voltage: $V_F(2) = 0.47 \text{ V} (\text{typ.})$



3. Packaging and Internal Circuit

2014-04-07

Rev.3.0

4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		40	V
Average rectified current	Ι _Ο	(Note 1)	1.5	А
Non-repetitive peak forward surge current	I _{FSM}	(Note 2)	5	А
Junction temperature	Тj		125	°C
Storage temperature	T _{stg}		-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

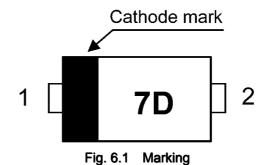
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Measured with a 10 ms pulse.

5. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F (1)	I _F = 1 A (Pulse test)		0.40	0.45	V
Forward voltage	V _F (2)	I _F = 1.5 A (Pulse test)	_	0.47	0.55	V
Reverse current	l _R	V _R = 40 V (Pulse test)	_	_	200	μA
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	170	_	pF

6. Marking



Marking Code	Part Number		
7D	CUS15S40		

7. Usage Considerations

• Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

Note 1: Mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm²)

8. Land Pattern Dimensions (for reference only)

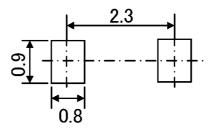


Fig. 8.1 Land Pattern Dimensions for Reference Only (Unit: mm)

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9. Characteristics Curves (Note)

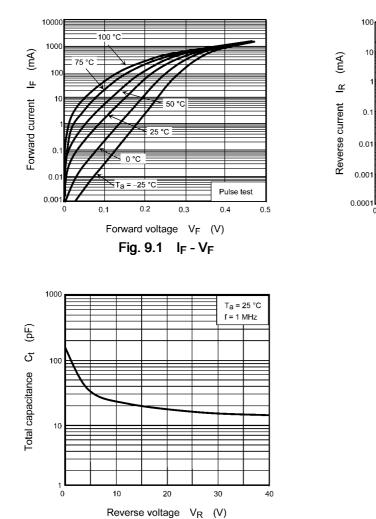


Fig. 9.3 Ct - VR

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Pulse test

10

75 °C =

°C

°C

°C

-25 °C

30

40

20

Reverse voltage V_R (V)

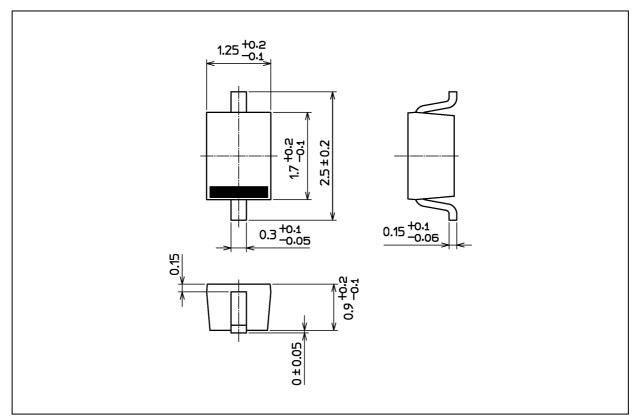
Fig. 9.2 I_R - V_R



CUS15S40

Package Dimensions

Unit: mm



Weight: 4.5 mg (typ.)

	Package Name(s)	
Nickname: USC		

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